Features and Benefits

- Low voltage supply: from 2.5V to 5.5V
- Chopper-stabilized amplifier stage
- Low power switch: 2.1mA
- Wide temperature range: -40°C to 150°C
- Automotive qualified: AEC-Q100
- Optimized ESD performance: 8kV
- Designed for standalone PCB applications
- TSOT-3L Green Compliant package

Application Examples

- Automotive, Consumer and Industrial
- BLDC motor commutation
- Solid-state Latch
- Low power applications
- Index counting
- Electrical power steering

Ordering Information

<table>
<thead>
<tr>
<th>Product Code</th>
<th>Temperature Code</th>
<th>Package Code</th>
<th>Option code</th>
<th>Packing form code</th>
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<tbody>
<tr>
<td>MLX92212</td>
<td>L</td>
<td>SE</td>
<td>AAA-000</td>
<td>RE</td>
</tr>
<tr>
<td>MLX92212</td>
<td>L</td>
<td>SE</td>
<td>ABA-000</td>
<td>RE</td>
</tr>
<tr>
<td>MLX92212</td>
<td>L</td>
<td>SE</td>
<td>ACA-000</td>
<td>RE</td>
</tr>
<tr>
<td>MLX92212</td>
<td>L</td>
<td>SE</td>
<td>ADA-000</td>
<td>RE</td>
</tr>
</tbody>
</table>

Legend:
Temperature code: L (-40 to 150°C)
Package Code: SE = TSOT-3L
Packing Form: RE = Reel
Ordering code
AAA = Very sensitive latch: Bop/Brp = 2mT/-2mT
ABA = Unipolar switch: Bop/Brp = 12.2mT/10.5mT
ACA = Unipolar switch: Bop/Brp = 10.1mT/8.3mT
ADA = Unipolar switch: Bop/Brp = 3mT/1.9mT

Ordering Example: MLX92212LSE-AAA-000-RE

1. Functional Diagram

2. General Description

The Melexis MLX92212 is a low voltage Hall-effect switch designed in mixed signal CMOS technology. The device integrates a voltage regulator, Hall sensor with advanced offset cancellation system and an open-drain output driver, all in a single package.

The device features a low voltage regulator with optimized performances targeting low power consumption at low voltage levels.

It is suitable for use in automotive applications thanks to its wide temperature range and extensive qualification according to automotive standards.

The MLX92212 is delivered in a Green compliant 3-pin Thin Small Outline Transistor (TSOT-3L) for surface-mount process.
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3. Glossary of Terms

MilliTesla (mT), Gauss  Units of magnetic flux density:
                      1mT = 10 Gauss
RoHS                 Restriction of Hazardous Substances
TSOT                 Thin Small Outline Transistor (TSOT package) – also referred with the Melexis package code “SE”
ESD                  Electro-Static Discharge
BLDC                 Brush-Less Direct-Current

4. Absolute Maximum Ratings

<table>
<thead>
<tr>
<th>Parameter</th>
<th>Symbol</th>
<th>Value</th>
<th>Units</th>
</tr>
</thead>
<tbody>
<tr>
<td>Supply Voltage</td>
<td>$V_{DD}$</td>
<td>-0.5 to 6</td>
<td>V</td>
</tr>
<tr>
<td>Supply Current (<code>1</code>)</td>
<td>$I_{DD}$</td>
<td>± 20</td>
<td>mA</td>
</tr>
<tr>
<td>Output Voltage</td>
<td>$V_{OUT}$</td>
<td>-0.5 to 6</td>
<td>V</td>
</tr>
<tr>
<td>Output Current (<code>1</code>)</td>
<td>$I_{OUT}$</td>
<td>± 20</td>
<td>mA</td>
</tr>
<tr>
<td>Operating Temperature Range</td>
<td>$T_A$</td>
<td>-40 to 150</td>
<td>°C</td>
</tr>
<tr>
<td>Storage Temperature Range</td>
<td>$T_S$</td>
<td>-50 to 165</td>
<td>°C</td>
</tr>
<tr>
<td>Maximum Junction Temperature</td>
<td>$T_J$</td>
<td>165</td>
<td>°C</td>
</tr>
<tr>
<td>ESD Sensitivity – HBM</td>
<td>-</td>
<td>8000(`2)</td>
<td>V</td>
</tr>
<tr>
<td>ESD Sensitivity – CDM</td>
<td>-</td>
<td>750</td>
<td>V</td>
</tr>
</tbody>
</table>

Exceeding the absolute maximum ratings may cause permanent damage.
Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

`1 Including current through the protection structure. Max Power dissipation should be also considered.
`2 Human Body Model according AEC-Q100-002 standard
5. General Electrical Specifications

DC Operating Parameters $T_A = -40$ to $150^\circ C$, $V_{DD} = 2.5V$ to $5.5V$ (unless otherwise specified)

<table>
<thead>
<tr>
<th>Parameter</th>
<th>Symbol</th>
<th>Test Conditions</th>
<th>Min</th>
<th>Typ</th>
<th>Max</th>
<th>Units</th>
</tr>
</thead>
<tbody>
<tr>
<td>Supply Voltage</td>
<td>$V_{DD}$</td>
<td>Operating</td>
<td>2.5</td>
<td>5.5</td>
<td>V</td>
<td></td>
</tr>
<tr>
<td>Supply Current</td>
<td>$I_{DD}$</td>
<td></td>
<td>1.3</td>
<td>2.1</td>
<td>3.2</td>
<td>mA</td>
</tr>
<tr>
<td>Output Saturation Voltage</td>
<td>$V_{DSON}$</td>
<td>$I_{OUT} = 5mA$, $B &gt; B_{OP}$</td>
<td>0.5</td>
<td>V</td>
<td></td>
<td></td>
</tr>
<tr>
<td>Output Leakage Current</td>
<td>$I_{OFF}$</td>
<td>$B &lt; B_{RP}$, $V_{OUT} = 5.5V$</td>
<td>0.01</td>
<td>10</td>
<td>$\mu A$</td>
<td></td>
</tr>
<tr>
<td>Output Current Limit</td>
<td>$I_{CL}$</td>
<td>$V_{OUT} = 2V$, $B &gt; B_{OP}$</td>
<td>10</td>
<td>16</td>
<td>mA</td>
<td></td>
</tr>
<tr>
<td>Output Rise Time (1)</td>
<td>$t_{r}$</td>
<td>$R_L = 1k\Omega$, $C_L = 50pF$</td>
<td>0.25</td>
<td>$\mu s$</td>
<td></td>
<td></td>
</tr>
<tr>
<td>Output Fall Time (1)</td>
<td>$t_{f}$</td>
<td>$R_L = 1k\Omega$, $C_L = 50pF$</td>
<td>0.25</td>
<td>$\mu s$</td>
<td></td>
<td></td>
</tr>
<tr>
<td>Power-On Time (2)</td>
<td>$t_{PON}$</td>
<td>$dV_{DD}/dt &gt; 2V/\mu s$</td>
<td>38</td>
<td>70</td>
<td>$\mu s$</td>
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<tr>
<td>Power-On State</td>
<td>$V_{POR}$</td>
<td></td>
<td>1.95</td>
<td>2.1</td>
<td>V</td>
<td></td>
</tr>
<tr>
<td>Maximum Switching Frequency (1)</td>
<td>$F_{SW}$</td>
<td>$B \geq 40mT$ and square wave magnetic field</td>
<td>10</td>
<td>KHz</td>
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</tr>
<tr>
<td>SE Package Thermal Resistance</td>
<td>$R_{TH}$</td>
<td>Single layer (1S) Jedeck board</td>
<td>300</td>
<td>$^\circ C/W$</td>
<td></td>
<td></td>
</tr>
</tbody>
</table>

1 Guaranteed by design and verified by characterization, not production tested
2 The Power-On time represents the time from reaching $V_{DD} = 2.5V$ to the first refresh of the output.
3 If VDD drops below $V_{POR}$ the output is reset to High state.
6. Magnetic Specification

6.1. MLX92212LSE-AAA-000-RE

DC Operating Parameters $T_A = -40 \, ^\circ C$ up to $150 \, ^\circ C$, $V_{DD} = 2.5V$ to $5.5V$ (unless otherwise specified)

<table>
<thead>
<tr>
<th>Parameter</th>
<th>Symbol</th>
<th>Test Conditions</th>
<th>Min</th>
<th>Typ</th>
<th>Max</th>
<th>Unit</th>
</tr>
</thead>
<tbody>
<tr>
<td>Operating Point</td>
<td>$B_{OP}$</td>
<td>$T_A = -40^\circ C$</td>
<td>0.6</td>
<td>2.1</td>
<td>3.8</td>
<td>mT</td>
</tr>
<tr>
<td></td>
<td></td>
<td>$T_A = 25^\circ C$</td>
<td>0.6</td>
<td>2.0</td>
<td>3.8</td>
<td>mT</td>
</tr>
<tr>
<td></td>
<td></td>
<td>$T_A = 150^\circ C$</td>
<td>0.6</td>
<td>1.9</td>
<td>3.8</td>
<td>mT</td>
</tr>
<tr>
<td>Release Point</td>
<td>$B_{RP}$</td>
<td>$T_A = -40^\circ C$</td>
<td>-3.8</td>
<td>-2.1</td>
<td>-0.6</td>
<td>mT</td>
</tr>
<tr>
<td></td>
<td></td>
<td>$T_A = 25^\circ C$</td>
<td>-3.8</td>
<td>-2.0</td>
<td>-0.6</td>
<td>mT</td>
</tr>
<tr>
<td></td>
<td></td>
<td>$T_A = 150^\circ C$</td>
<td>-3.8</td>
<td>-1.9</td>
<td>-0.6</td>
<td>mT</td>
</tr>
<tr>
<td>Hysteresis</td>
<td>$B_{HYST}$</td>
<td>$T_A = -40^\circ C$</td>
<td>1.7</td>
<td>4.2</td>
<td>6.8</td>
<td>mT</td>
</tr>
<tr>
<td></td>
<td></td>
<td>$T_A = 25^\circ C$</td>
<td>1.7</td>
<td>4.0</td>
<td>6.8</td>
<td>mT</td>
</tr>
<tr>
<td></td>
<td></td>
<td>$T_A = 150^\circ C$</td>
<td>1.7</td>
<td>3.8</td>
<td>6.8</td>
<td>mT</td>
</tr>
</tbody>
</table>

6.2. MLX92212LSE-ABA-000-RE

DC Operating Parameters, $T_A = -40 \, ^\circ C$ up to $150 \, ^\circ C$, $V_{DD} = 2.5V$ to $5.5V$ (unless otherwise specified)

<table>
<thead>
<tr>
<th>Parameter</th>
<th>Symbol</th>
<th>Test Conditions</th>
<th>Min</th>
<th>Typ</th>
<th>Max</th>
<th>Unit</th>
</tr>
</thead>
<tbody>
<tr>
<td>Operating Point</td>
<td>$B_{OP}$</td>
<td>$T_A = -40^\circ C$</td>
<td>9.2</td>
<td>12.7</td>
<td>16.6</td>
<td>mT</td>
</tr>
<tr>
<td></td>
<td></td>
<td>$T_A = 25^\circ C$</td>
<td>9.4</td>
<td>12.2</td>
<td>15.4</td>
<td>mT</td>
</tr>
<tr>
<td></td>
<td></td>
<td>$T_A = 85^\circ C$</td>
<td>9.2</td>
<td>12.3</td>
<td>15.4</td>
<td>mT</td>
</tr>
<tr>
<td></td>
<td></td>
<td>$T_A = 125^\circ C$</td>
<td>8.8</td>
<td>12.4</td>
<td>16.0</td>
<td>mT</td>
</tr>
<tr>
<td></td>
<td></td>
<td>$T_A = 150^\circ C$</td>
<td>8.2</td>
<td>12.5</td>
<td>16.8</td>
<td>mT</td>
</tr>
<tr>
<td>Release Point</td>
<td>$B_{RP}$</td>
<td>$T_A = -40^\circ C$</td>
<td>7.6</td>
<td>11</td>
<td>14.4</td>
<td>mT</td>
</tr>
<tr>
<td></td>
<td></td>
<td>$T_A = 25^\circ C$</td>
<td>7.8</td>
<td>10.5</td>
<td>13.4</td>
<td>mT</td>
</tr>
<tr>
<td></td>
<td></td>
<td>$T_A = 85^\circ C$</td>
<td>7.8</td>
<td>10.6</td>
<td>13.4</td>
<td>mT</td>
</tr>
<tr>
<td></td>
<td></td>
<td>$T_A = 125^\circ C$</td>
<td>7.4</td>
<td>10.7</td>
<td>13.9</td>
<td>mT</td>
</tr>
<tr>
<td></td>
<td></td>
<td>$T_A = 150^\circ C$</td>
<td>6.8</td>
<td>10.8</td>
<td>14.8</td>
<td>mT</td>
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</table>
### 6.3. MLX92212LSE-ACA-000-RE

DC Operating Parameters, $T_A = -40^\circ C$ up to $150^\circ C$, $V_{DD} = 2.5V$ to $5.5V$ (unless otherwise specified)

<table>
<thead>
<tr>
<th>Parameter</th>
<th>Symbol</th>
<th>Test Conditions</th>
<th>Min</th>
<th>Typ</th>
<th>Max</th>
<th>Unit</th>
</tr>
</thead>
<tbody>
<tr>
<td>Operating Point</td>
<td>$B_{OP}$</td>
<td>$T_A = -40^\circ C$</td>
<td>7.8</td>
<td>11.5</td>
<td>15.1</td>
<td>mT</td>
</tr>
<tr>
<td></td>
<td></td>
<td>$T_A = 25^\circ C$</td>
<td>6.9</td>
<td>10.1</td>
<td>13.3</td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td>$T_A = 150^\circ C$</td>
<td>5.3</td>
<td>7.6</td>
<td>9.9</td>
<td></td>
</tr>
<tr>
<td>Release Point</td>
<td>$B_{RP}$</td>
<td>$T_A = -40^\circ C$</td>
<td>5.9</td>
<td>9.3</td>
<td>12.7</td>
<td>mT</td>
</tr>
<tr>
<td></td>
<td></td>
<td>$T_A = 25^\circ C$</td>
<td>5.3</td>
<td>8.3</td>
<td>11.3</td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td>$T_A = 150^\circ C$</td>
<td>4.2</td>
<td>6.6</td>
<td>9.0</td>
<td></td>
</tr>
<tr>
<td>Temperature</td>
<td>TC</td>
<td></td>
<td>-2000(1)</td>
<td></td>
<td>ppm/°C</td>
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</tr>
<tr>
<td>coefficient</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
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</tbody>
</table>

### 6.4. MLX92212LSE-ADA-000-RE

DC Operating Parameters $T_A = -40^\circ C$ up to $150^\circ C$, $V_{DD} = 2.5V$ to $5.5V$ (unless otherwise specified)

<table>
<thead>
<tr>
<th>Parameter</th>
<th>Symbol</th>
<th>Test Conditions</th>
<th>Min</th>
<th>Typ</th>
<th>Max</th>
<th>Unit</th>
</tr>
</thead>
<tbody>
<tr>
<td>Operating Point</td>
<td>$B_{OP}$</td>
<td>$T_A = -40^\circ C$</td>
<td>1.8</td>
<td>3.0</td>
<td>4.5</td>
<td>mT</td>
</tr>
<tr>
<td></td>
<td></td>
<td>$T_A = 25^\circ C$</td>
<td>1.8</td>
<td>3.0</td>
<td>4.5</td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td>$T_A = 150^\circ C$</td>
<td>1.8</td>
<td>2.8</td>
<td>4.5</td>
<td></td>
</tr>
<tr>
<td>Release Point</td>
<td>$B_{RP}$</td>
<td>$T_A = -40^\circ C$</td>
<td>0.8</td>
<td>1.8</td>
<td>3.0</td>
<td>mT</td>
</tr>
<tr>
<td></td>
<td></td>
<td>$T_A = 25^\circ C$</td>
<td>0.8</td>
<td>1.9</td>
<td>3.0</td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td>$T_A = 150^\circ C$</td>
<td>0.8</td>
<td>1.8</td>
<td>3.0</td>
<td></td>
</tr>
<tr>
<td>Hysteresis</td>
<td>$B_{HYST}$</td>
<td>$T_A = -40^\circ C$</td>
<td>0.5</td>
<td>1.2</td>
<td>2.0</td>
<td>mT</td>
</tr>
<tr>
<td></td>
<td></td>
<td>$T_A = 25^\circ C$</td>
<td>0.5</td>
<td>1.1</td>
<td>2.0</td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td>$T_A = 150^\circ C$</td>
<td>0.5</td>
<td>1.0</td>
<td>2.0</td>
<td></td>
</tr>
</tbody>
</table>

---

1 Temperature coefficient is calculated using the following formula:

$$ \frac{B_{OP2} - B_{OP1}}{B_{OP1} \times (T_2 - T_1)} \times 10^6 \text{ ppm/}^\circ C; T_1 = 25^\circ C; T_2 = 150^\circ C $$

Value guaranteed by design and verified by characterization, not production tested.
7. Output behaviour versus Magnetic Field

7.1. Latch sensor
Valid for MLX92212LSE-AAA-000

<table>
<thead>
<tr>
<th>Parameter (1)</th>
<th>Test Conditions</th>
<th>OUT</th>
</tr>
</thead>
<tbody>
<tr>
<td>South pole</td>
<td>B &gt; B_{OP}</td>
<td>Low</td>
</tr>
<tr>
<td>North pole</td>
<td>B &lt; B_{RP}</td>
<td>High</td>
</tr>
</tbody>
</table>

7.2. Switch sensor
Valid for: MLX92212LSE-ABA-000, MLX92212LSE-ACA-000 and MLX92212LSE-ADA-000

<table>
<thead>
<tr>
<th>Parameter (1)</th>
<th>Test Conditions</th>
<th>OUT</th>
</tr>
</thead>
<tbody>
<tr>
<td>South pole</td>
<td>B &gt; B_{OP}</td>
<td>Low</td>
</tr>
<tr>
<td>North pole (2)</td>
<td>B &lt; B_{RP}</td>
<td>High</td>
</tr>
</tbody>
</table>

1 Magnetic pole facing the branded / top side of the package
2 North pole or absence of field or South field lower then Brp (ABA/ACA/ADA version)
8. Detailed General Description

Based on mixed signal CMOS technology, Melexis MLX92212LSE-AAA-000 is a Hall-effect device with very high magnetic sensitivity. Melexis MLX92212LSE-ABA-000 is a Hall-effect device with a low hysteresis covering higher magnetic fields. Both versions are allowing the use of generic magnets, weak magnets or larger air gap.

The chopper-stabilized amplifier uses switched capacitor techniques to suppress the offset generally observed with Hall sensors and amplifiers. The CMOS technology makes this advanced technique possible and contributes to smaller chip size and lower current consumption than bipolar technology. The small chip size is also an important factor to minimize the effect of physical stress. This combination results in more stable magnetic characteristics and enables faster and more precise design.

The operating voltage from 2.5V to 5.5V, low current consumption and large choice of operating temperature range according to “L” specification make this device suitable for automotive, industrial and consumer low voltage applications.

The output signal is open-drain type. Such output allows simple connectivity with TTL or CMOS logic by using a pull-up resistor tied between a pull-up voltage and the device output.

9. Latch/Switch characteristics

The MLX92212-AAA exhibits magnetic latching characteristics.

Typically, the device behaves as a latch with symmetric operating and release switching points ($B_{OP} = |B_{RP}|$). This means magnetic fields with equivalent strength and opposite direction drive the output high and low.

Removing the magnetic field ($B \rightarrow 0$) keeps the output in its previous state. This latching property defines the device as a magnetic memory.

The MLX92212LSE-ABA, MLX92212LSE-ACA-000 and MLX92212LSE-ADA-000 exhibits magnetic switching characteristics.

The device is south pole active: Applying a south magnetic pole greater than $B_{OP}$ facing the branded side of the package switches the output low.

Removing the magnetic field ($B \rightarrow 0$) switches the output high. The use of the opposite magnetic pole facing the branded side does not affect the output state.
10. Performance graphs

10.1. MLX92212LSE -AAA-000

Typical Magnetic switch points vs Temperature

- Bop, Vdd = 2.5V
- Bop, Vdd = 5.5V
- Brp, Vdd = 2.5V
- Brp, Vdd = 5.5V

Typical Magnetic switch points vs Vdd

- Bop, Tj = -40 °C
- Bop, Tj = 150 °C
- Brp, Tj = -40 °C
- Brp, Tj = 150 °C

Typical Supply current vs Temperature

- Idd, Vdd = 2.5V
- Idd, Vdd = 5.5V

Typical Supply current vs Vdd

- Idd, Temp = -40degC
- Idd, Temp = 150 degC

10.2. MLX92212LSE -ABA-000

Typical Magnetic switch points vs Temperature

- Bop, Vdd = 2.5V
- Bop, Vdd = 5.5V
- Brp, Vdd = 2.5V
- Brp, Vdd = 5.5V

Typical Magnetic switch points vs Vdd

- Bop, Tj = -40 °C
- Bop, Tj = 150 °C
- Brp, Tj = -40 °C
- Brp, Tj = 150 °C
10.3. MLX92212LSE -ACA-000

Typical Magnetic switch points vs Temperature

Typical Magnetic switch points vs Vdd

10.4. MLX92212LSE -ADA-000

Typical Magnetic switch points vs Temperature

Typical Magnetic switch points vs Vdd
11. Application Information

11.1. Typical Three-Wire Application Circuit

![Typical Three-Wire Application Circuit Diagram]

Notes:
1. For proper operation, a 10nF to 100nF bypass capacitor should be placed as close as possible to the VDD and ground pin.
2. A capacitor connected to the output is not obligatory, because the output slope is generated internally.

11.2. Automotive and Harsh, Noisy Environments Three-Wire Circuit

![Automotive and Harsh, Noisy Environments Three-Wire Circuit Diagram]

Notes:
1. For proper operation, a 10nF to 100nF bypass capacitor should be placed as close as possible to the VDD and ground pin.
2. The device could tolerate negative voltage down to -0.5 V, so if negative transients over supply line VPEAK< -32V are expected, usage of the diode D1 is recommended. Otherwise only R1 is sufficient. When selecting the resistor R1, three points are important:
   - the resistor has to limit $I_{DD}/I_{DDREV}$ to 40mA maximum
   - the resistor has to withstand the power dissipated in both over voltage conditions ($V_{DD}$ / R1)
   - the resulting device supply voltage $V_{DD}$ has to be higher than $V_{DD}$ min ($V_{DD} = V_{CC} - R_1 I_{DD}$)
3. The device could tolerate positive supply voltage up to +6V (until the maximum power dissipation is not exceeded), so if positive transients over supply line with $V_{PEAK} > 6V$ are expected, usage a zener diode Z1 is recommended. The R1-Z1 network should be sized to limit the voltage over the device below the maximum allowed.
12. Standard information

12.1. Storage and handling of plastic encapsulated ICs

Plastic encapsulated ICs shall be stored and handled according to their MSL categorization level (specified in the packing label) as per J-STD-033.

Electronic semiconductor products are sensitive to Electro Static Discharge (ESD). The component assembly shall be handled in EPA (Electrostatic Protected Area) as per ANSI S20.20

For more information refer to Melexis Guidelines for storage and handling of plastic encapsulated ICs [1]

12.2. Assembly of encapsulated ICs

For Surface Mounted Devices (SMD, as defined according to JEDEC norms), the only applicable soldering method is reflow.

For Through Hole Devices (THD), the applicable soldering methods are reflow, wave, selective wave and robot point-to-point. THD lead pre-forming (cutting and/or bending) is applicable under strict compliance with Melexis Guidelines for lead forming of SIP Hall Sensors [1].

Melexis products soldering on PCB should be conducted according to the requirements of IPC/JEDEC and J-STD-001. Solder quality acceptance should follow the requirements of IPC-A-610.

For PCB-less assembly refer to the relevant application notes [1] or contact Melexis.

Electrical resistance welding or laser welding can be applied to Melexis products in THD and specific PCB-less packages following the Guidelines for welding of PCB-less devices[1].

Environmental protection of customer assembly with Melexis products for harsh media application, is applicable by means of coating, potting or overmolding considering restrictions listed in the relevant application notes [9]

For other specific process, contact Melexis via www.melexis.com/technical-inquiry

12.3. Environment and sustainability

Melexis is contributing to global environmental conservation by promoting non-hazardous solutions. For more information on our environmental policy and declarations (RoHS, REACH...) visit www.melexis.com/environmental-forms-and-declarations

13. Package Information

13.1. TSOT-3L (SE Package)

13.1.1. TSOT-3L – package dimensions

NOTE:
1. ALL DIMENSIONS IN MILLIMETERS (mm) UNLESS OTHERWISE STATED.
2. DIMENSION D DOES NOT INCLUDE MOLD FLASH OR PROTRUSIONS OF MAX 0.15 mm PER SIDE.
3. DIMENSION E DOES NOT INCLUDE MOLD FLASH OR PROTRUSIONS OF MAX 0.25 mm PER SIDE.
4. DIMENSION b DOES NOT INCLUDE CANGAR PROTRUSION OF MAX 0.07 mm.
5. DIMENSION L IS THE LENGTH OF THE TERMINAL FOR SOLDERING TO A SUBSTRATE.
6. FORMED LEAD SHALL BE PLANAR WITH RESPECT TO ONE ANOTHER WITH 0.076 mm SEATING PLANE.

13.1.2. TSOT-3L – Sensitive spot
13.1.3. TSOT-3L – Package marking / pin definition

Top

AAA version: YY (YY = Year code)
ABA version: BY (Y = Year code)
ACA version: CY (Y = Year code)
ADA version: DY (Y = Year code)

Fixed characters MLX92212

Bottom

3rd to 6th digits from lot#

<table>
<thead>
<tr>
<th>Pin #</th>
<th>Name</th>
<th>Type</th>
<th>Function</th>
</tr>
</thead>
<tbody>
<tr>
<td>1</td>
<td>VDD</td>
<td>Supply</td>
<td>Supply Voltage pin</td>
</tr>
<tr>
<td>2</td>
<td>OUT</td>
<td>Out</td>
<td>Open drain output pin</td>
</tr>
<tr>
<td>3</td>
<td>GND</td>
<td>Ground</td>
<td>Ground pin</td>
</tr>
</tbody>
</table>
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